Ordering number : ENA0748A

SANYO Semiconductors
DATA SHEET

N-Channel Silicon MOSFET

2SK4126 — General-Purpose Switching Device Applications

Features

- Low ON-resistance, low input capacitance, ultrahigh-speed switching.
- Adoption of high reliability HVP process.
- Avalanche resistance guarantee.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		650	V
Gate-to-Source Voltage	V_{GSS}		±30	V
Drain Current (DC)	I_D		15	A
Drain Current (Pulse)	I_{DP}	PW≤10μs, duty cycle≤1%	48	A
Allowable Power Dissipation	P_D		2.5	W
		Tc=25°C (SANYO's ideal heat dissipation condition)*1	170	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		−55 to +150	°C
Avalanche Energy (Single Pulse) *2	E_{AS}		132	mJ
Avalanche Current *3	I_{AV}		15	A

*1 SANYO's condition is radiation from backside.

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminium.

*2 V_{DD}=99V, L=1mH, I_{AV}=15A

*3 L≤1mH, single pulse

Marking : K4126

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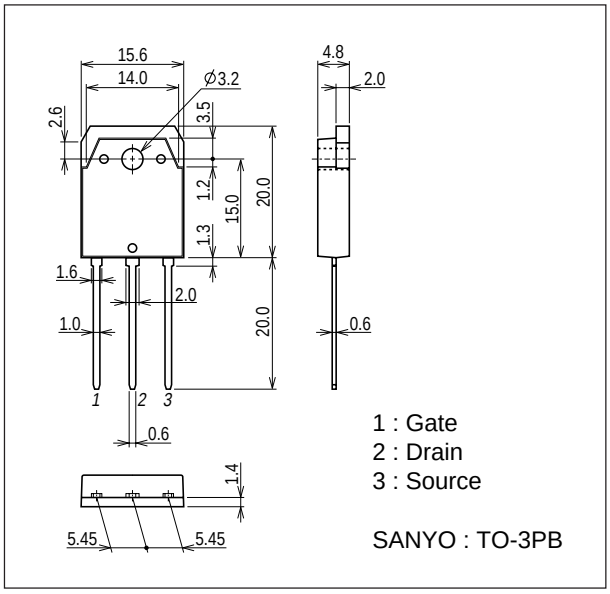
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	I_D=10mA, V_{GS}=0V	650			V
Zero-Gate Voltage Drain Current	I_{DSS}	V_{DS}=520V, V_{GS}=0V			100	μA
Gate-to-Source Leakage Current	I_{GSS}	V_{GS}=±30V, V_{DS}=0V			±100	nA
Cutoff Voltage	$V_{GS}(off)$	V_{DS}=10V, I_D=1mA	3		5	V
Forward Transfer Admittance	$\|yfs\|$	V_{DS}=10V, I_D=7.5A	4.1	8.2		S
Static Drain-to-Source On-State Resistance	$R_{DS}(on)$	I_D=6A, V_{GS}=10V		0.55	0.72	Ω
Input Capacitance	Ciss	V_{DS}=30V, f=1MHz		1200		pF
Output Capacitance	Coss	V_{DS}=30V, f=1MHz		208		pF
Reverse Transfer Capacitance	Crss	V_{DS}=30V, f=1MHz		44		pF
Turn-ON Delay Time	$t_d(on)$	See specified Test Circuit.		27		ns
Rise Time	t_r	See specified Test Circuit.		80		ns
Turn-OFF Delay Time	$t_d(off)$	See specified Test Circuit.		45		ns
Fall Time	t_f	See specified Test Circuit.		50		ns
Total Gate Charge	Qg	V_{DS}=200V, V_{GS}=10V, I_D=15A		45.4		nC
Gate-to-Source Charge	Qgs	V_{DS}=200V, V_{GS}=10V, I_D=15A		8.3		nC
Gate-to-Drain “Miller” Charge	Qgd	V_{DS}=200V, V_{GS}=10V, I_D=15A		25.8		nC
Diode Forward Voltage	V_{SD}	I_S=15A, V_{GS}=0V		0.95	1.3	V

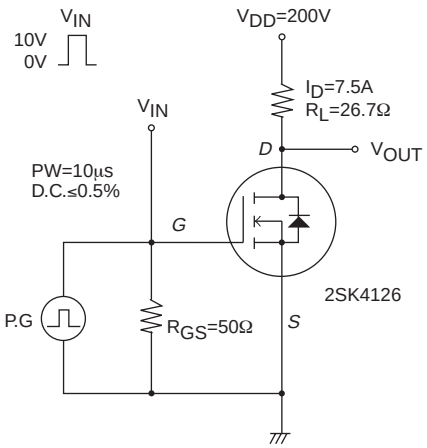
Package Dimensions

unit : mm (typ)

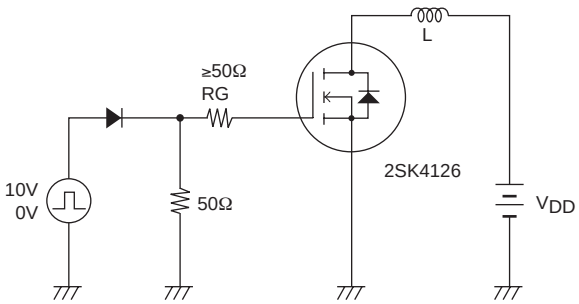
7503-004

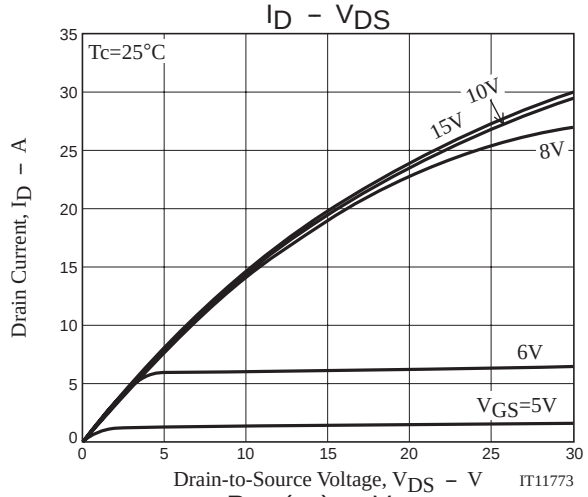


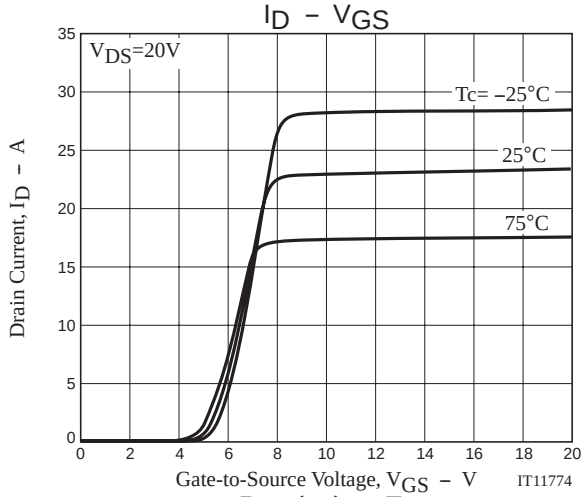
Switching Time Test Circuit

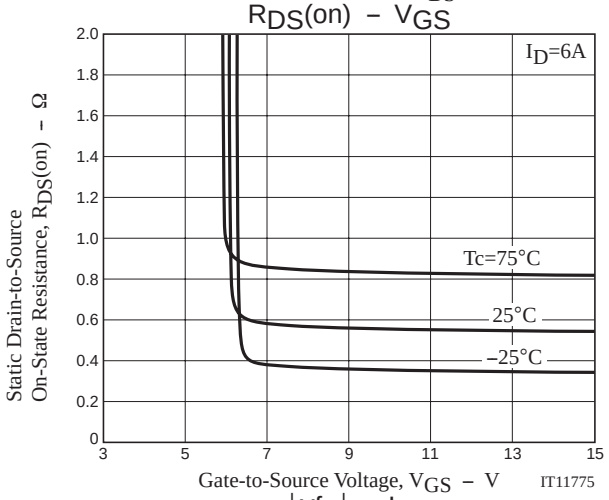


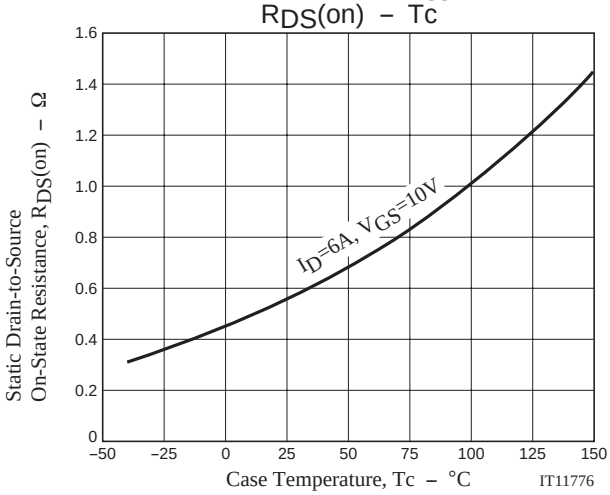
Avalanche Resistance Test Circuit

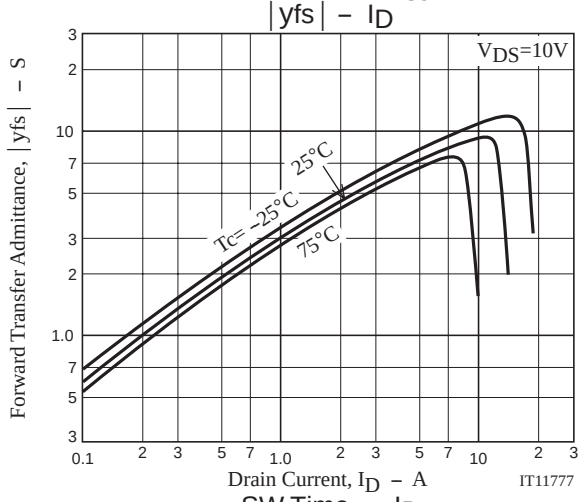


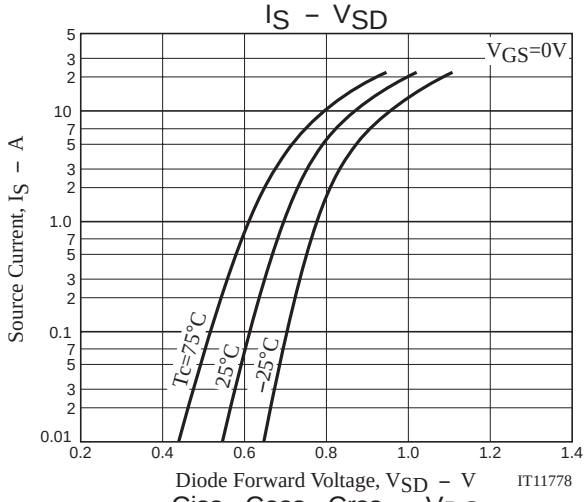

ID – VDS
Tc=25°C
10V
15V
8V
6V
VGS=5V
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT11773

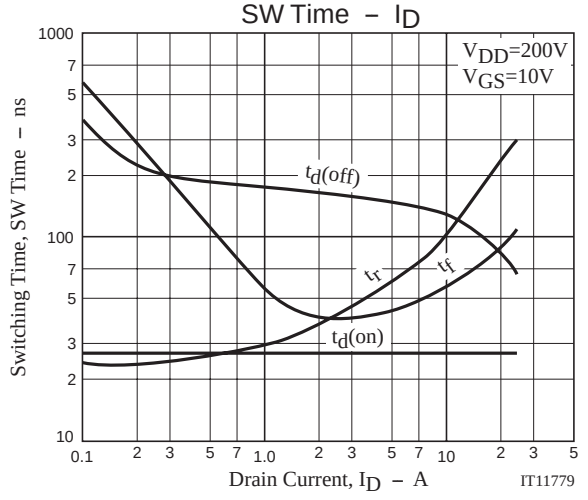

ID – VGS
VDS=20V
Tc= –25°C
25°C
75°C
Drain Current, ID – A
Gate-to-Source Voltage, VGS – V
IT11774

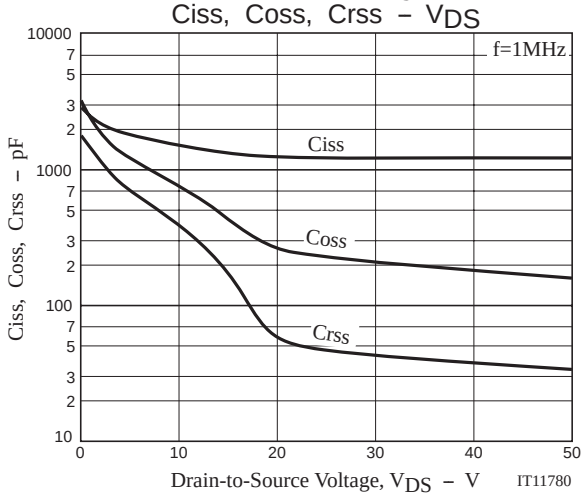

RDS(on) – VGS
ID=6A
Tc=75°C
25°C
–25°C
Static Drain-to-Source On-State Resistance, RDS(on) – Ω
Gate-to-Source Voltage, VGS – V
IT11775

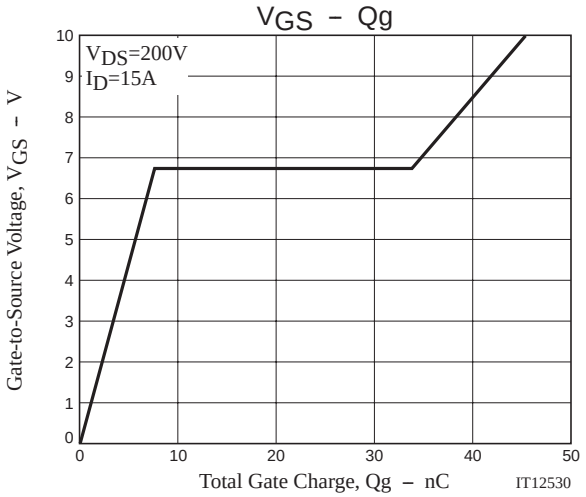

RDS(on) – Tc
ID=6A, VGS=10V
Static Drain-to-Source On-State Resistance, RDS(on) – Ω
Case Temperature, Tc – °C
IT11776

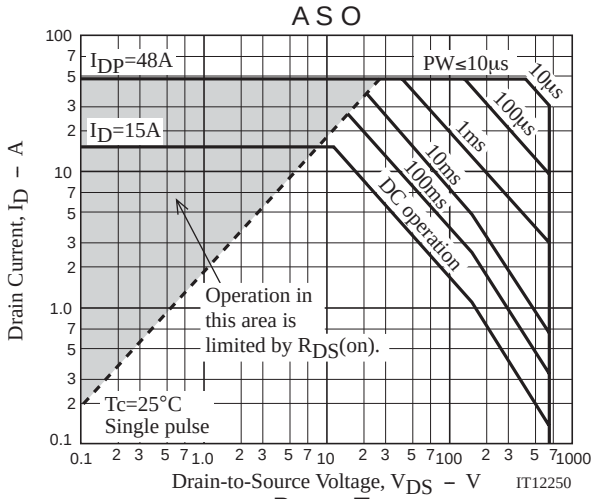

| yfs | – ID
VDS=10V
25°C
Tc= –25°C
75°C
Forward Transfer Admittance, | yfs | – S
Drain Current, ID – A
IT11777

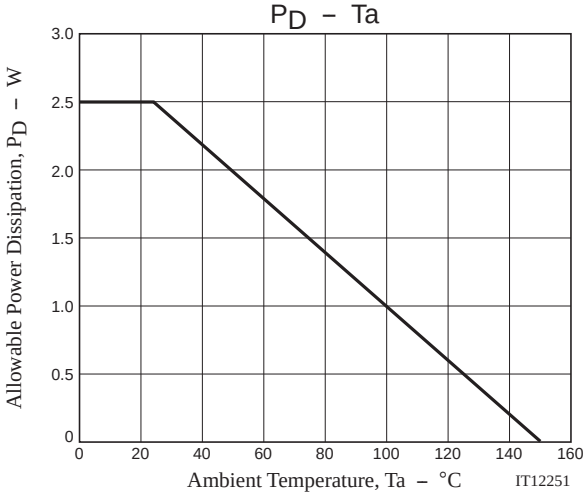

IS – VSD
VGS=0V
Tc=75°C
25°C
–25°C
Source Current, IS – A
Diode Forward Voltage, VSD – V
IT11778

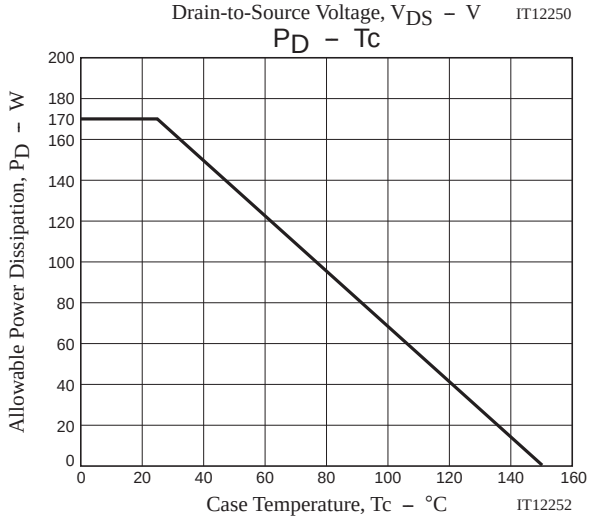

SW Time – ID
VDD=200V
VGS=10V
td(off)
tf
tr
td(on)
Switching Time, SW Time – ns
Drain Current, ID – A
IT11779

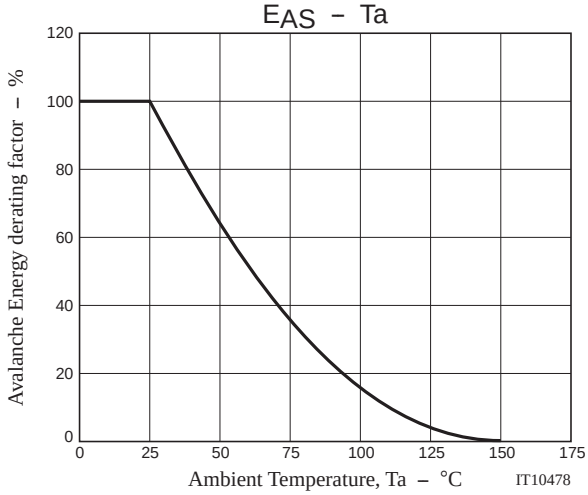

Ciss, Coss, Crss – VDS
f=1MHz
Ciss
Coss
Crss
Ciss, Coss, Crss – pF
Drain-to-Source Voltage, VDS – V
IT11780


VGS – Qg
VDS=200V
ID=15A
Gate-to-Source Voltage, VGS – V
Total Gate Charge, Qg – nC
IT12530


A S O
IDP=48A
ID=15A
PW≤10μs
10μs
100μs
1ms
10ms
100ms
DC operation
Operation in this area is limited by RDS(on).
Tc=25°C
Single pulse
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT12250


PD – Ta
Allowable Power Dissipation, PD – W
Ambient Temperature, Ta – °C
IT12251


PD – Tc
Allowable Power Dissipation, PD – W
Case Temperature, Tc – °C
IT12252


EAS – Ta
Avalanche Energy derating factor – %
Ambient Temperature, Ta – °C
IT10478

Note on usage : Since the 2SK4126 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

This catalog provides information as of December, 2007. Specifications and information herein are subject to change without notice.